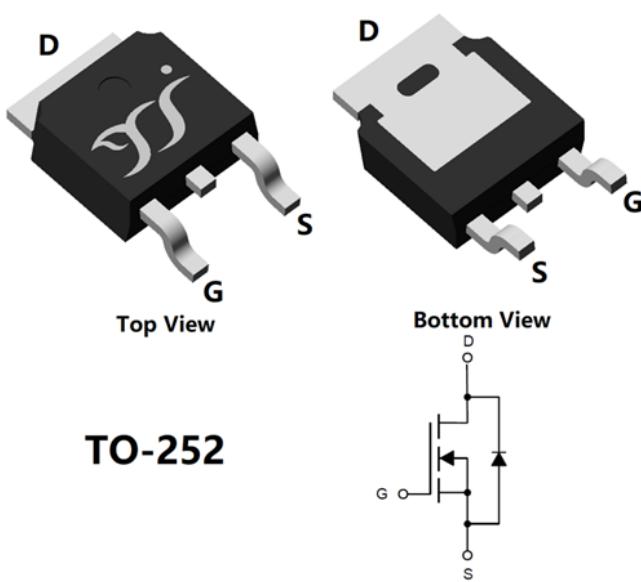




## N-Channel Enhancement Mode Field Effect Transistor



### Product Summary

- $V_{DS}$  650V
- $I_D$  11A
- $R_{DS(ON)}$  (at  $V_{GS}=10V$ )  $<380m\Omega$
- 100% EAS Tested
- 100%  $\nabla V_{DS}$  Tested

### General Description

- Super Junction High Voltage MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

### Applications

- Switching Mode Power Supplies (SMPS)
- PWM Motor Controls
- LED Lighting
- Adapter

### ■ Limiting Values

Parameter	Conditions		Symbol	Min	Max	Unit
Drain-source Voltage			$V_{DS}$	-	650	V
Gate-source Voltage			$V_{GS}$	-30	30	
Continuous Drain Current (Note 1,2)	Steady-State	$T_A=25^\circ C, V_{GS}=10V$	$I_D$	-	1.6	A
		$T_A=100^\circ C, V_{GS}=10V$		-	1	
Continuous Drain Current (Note 1,3)	Steady-State	$T_c=25^\circ C, V_{GS}=10V$		-	11	
		$T_c = 100^\circ C, V_{GS}=10V$		-	6.9	
Pulsed Drain Current	$T_c=25^\circ C, t_p \leq 10\mu s$		$I_{DM}$	-	24	
Maximum Body-Diode Continuous Current	$T_c=25^\circ C$		$I_S$	-	11	
Maximum Body-Diode Pulsed Current	$T_c=25^\circ C, t_p \leq 10\mu s$		$I_{SM}$	-	24	
Avalanche Energy (non-repetitive)	$T_J=25^\circ C, V_G=10V, R_G=25\Omega, L=30mH, IAS=2.5A$		EAS	-	93.75	mJ
Total Power Dissipation (Note 1,2)	Steady-State	$T_A=25^\circ C$	$P_D$	-	2.6	W
		$T_A=100^\circ C$		-	1	
Total Power Dissipation (Note 1,3)	Steady-State	$T_c=25^\circ C$		-	73	
		$T_c = 100^\circ C$		-	29	
MOSFET dv/dt Ruggedness	$V_{DS}=0...325V, ID \leq 7.5A, R_g=0\Omega$		dv/dt	-	53	V/ns
Reverse Diode dv/dt	$V_{DS}=0...325V, ID \leq 7.5A, di/dt=200A/us$		dv/dt	-	18.3	
Maximum Diode Commutation Speed	$V_{DS}=0...325V, ID \leq 7.5A, R_g=0\Omega$		dif/dt	-	3125	A/us
Junction and Storage Temperature Range			$T_J, T_{STG}$	-55	150	°C

### ■ Thermal Resistance

Parameter	Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient (Note 2)	$R_{\theta JA}$	-	48	°C/W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	-	1.7	

### ■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJD380D65CHJ	F2	D380D65CHJ	2500	/	25000	13" reel



## ■ Electrical Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A, T_j=25^\circ C$	650	-	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=650V, V_{GS}=0V, T_j=25^\circ C$	-	-	1	$\mu A$
		$V_{DS}=650V, V_{GS}=0V, T_j=150^\circ C$	-	-	100	
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 30V, V_{DS}=0V, T_j=25^\circ C$	-	-	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A, T_j=25^\circ C$	2.2	3	3.8	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=5A, T_j=25^\circ C$	-	300	380	$m\Omega$
		$V_{GS}=10V, I_D=5A, T_j=150^\circ C$	-	768	972	
Diode Forward Voltage	$V_{SD}$	$I_S=1A, V_{GS}=0V, T_j=25^\circ C$	-	0.89	1.2	V
Gate Resistance	$R_G$	$f=1MHz, T_j=25^\circ C$	-	4	-	$\Omega$
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=325V, V_{GS}=0V, f=1MHz, T_j=25^\circ C$	-	625	-	pF
Output Capacitance	$C_{oss}$		-	4.7	-	
Reverse Transfer Capacitance	$C_{rss}$		-	1.3	-	
Effective Output capacitance, Energy Related	$C_{o(er)}$	$V_{DS}=0\dots 325V, V_{GS}=0V, f=1MHz, T_j=25^\circ C$	-	29	-	
Effective Output Capacitance, Time Related	$C_{o(tr)}$		-	170	-	
<b>Switching Parameters</b>						
Total Gate Charge	$Q_g$	$V_{GS}=10V, V_{DS}=325V, I_D=8.5A, T_j=25^\circ C$	-	13.7	-	nC
Gate-Source Charge	$Q_{gs}$		-	3	-	
Gate-Drain Charge	$Q_{gd}$		-	5.7	-	
Reverse Recovery Charge	$Q_{rr}$	$I_F=8.5A, di/dt=100A/\mu s, V_{GS}=0V, V_R=325V, T_j=25^\circ C$	-	2086	-	nC
Reverse Recovery Time	$t_{rr}$		-	208	-	ns
Peak Reverse Recovery Current	$I_{rm}$		-	19	-	A
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=10V, V_{DS}=325V, I_D=8.5A, R_{GEN}=3\Omega, T_j=25^\circ C$	-	30	-	ns
Turn-on Rise Time	$t_r$		-	23	-	
Turn-off Delay Time	$t_{D(off)}$		-	18	-	
Turn-off Fall Time	$t_f$		-	13	-	

### Note:

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- The value of  $R_{\theta JA}$  is measured with the device mounted on the 40mm\*40mm\*1.1mm single layer FR-4 PCB board with 1 in<sup>2</sup> pad of 2oz. Copper, in the still air environment with  $T_A=25^\circ C$ . The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.
- Thermal resistance from junction to soldering point (on the exposed drain pad).

## ■ Typical Electrical and Thermal Characteristics Diagrams

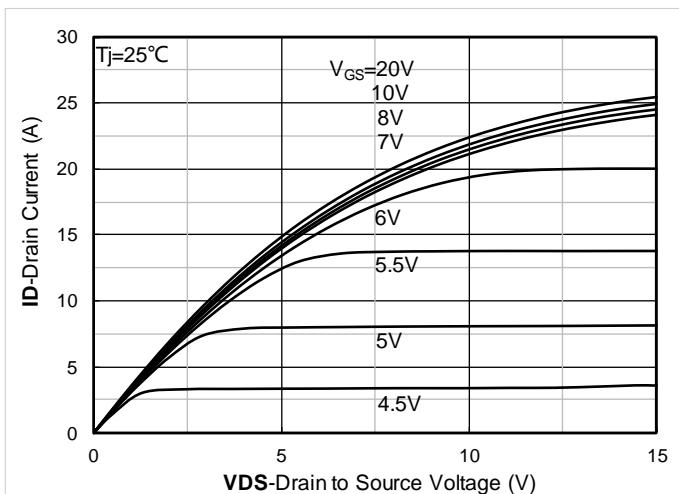


Figure 1. Output Characteristics; typical values

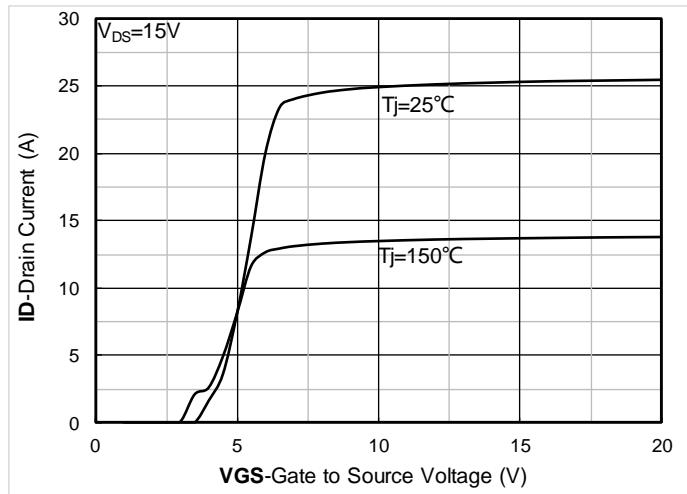


Figure 2. Transfer Characteristics; typical values

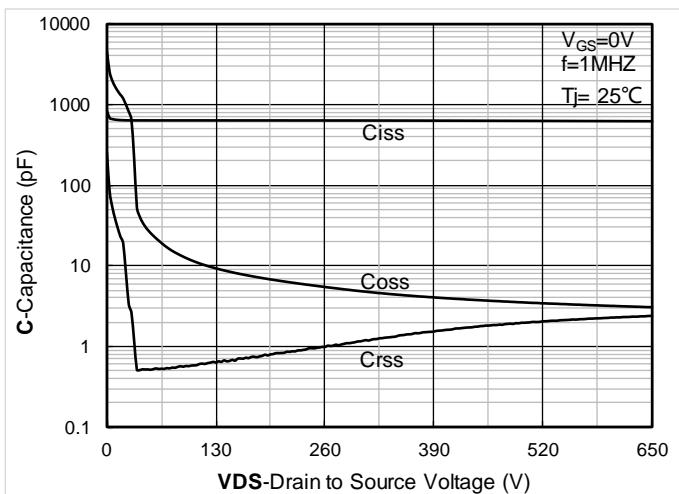


Figure 3. Capacitance Characteristics; typical values

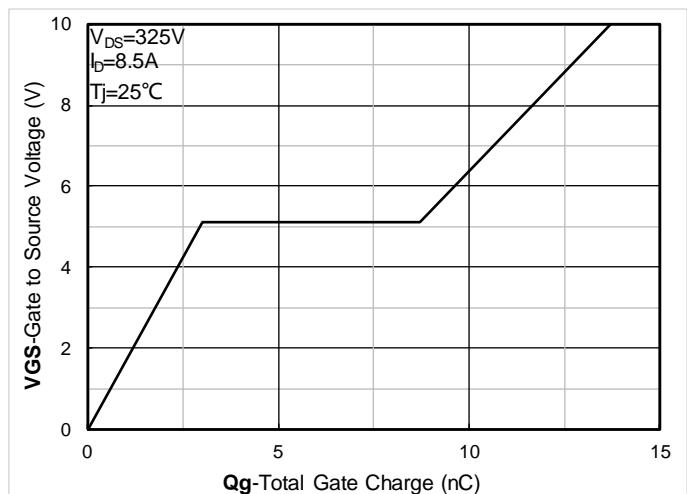


Figure 4. Gate Charge; typical values

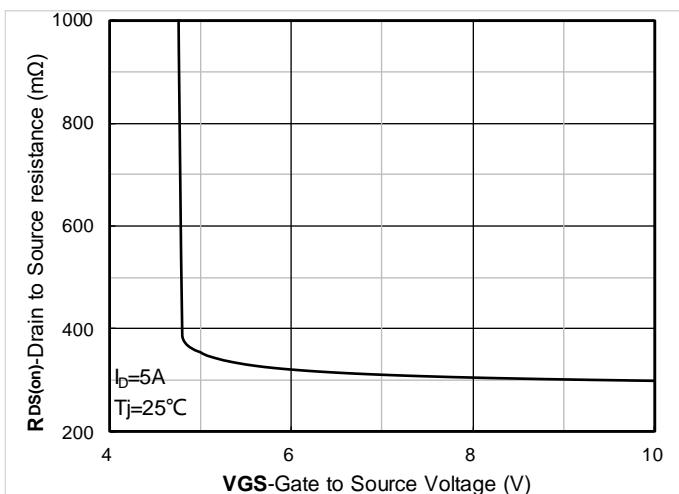


Figure 5. On-Resistance vs. Gate to Source Voltage; typical values

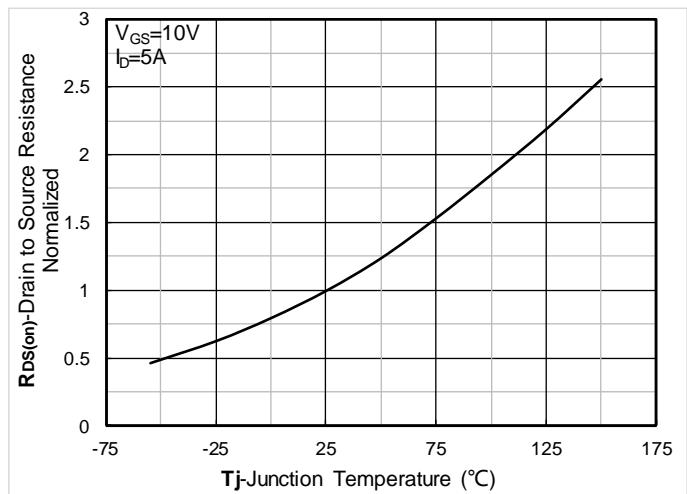


Figure 6. Normalized On-Resistance



# YJD380D65CHJ

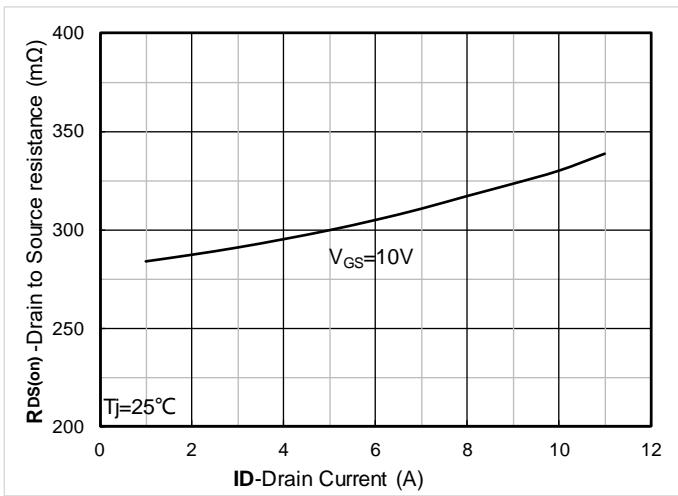


Figure 7.  $R_{DS(on)}$  vs. Drain Current; typical values

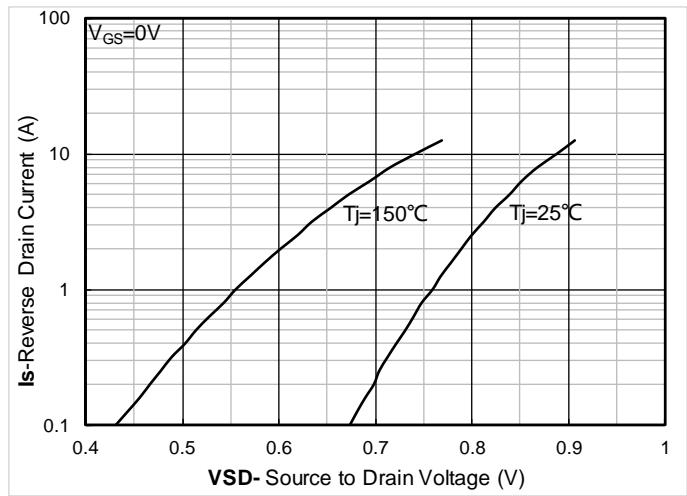


Figure 8. Forward characteristics of reverse diode; typical values

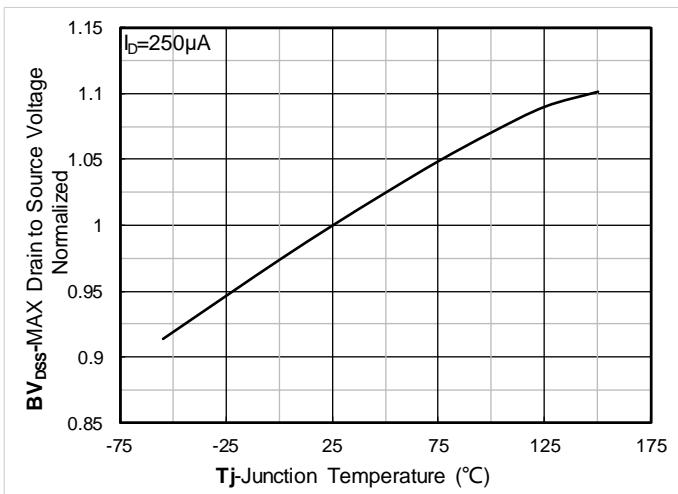


Figure 9. Normalized breakdown voltage

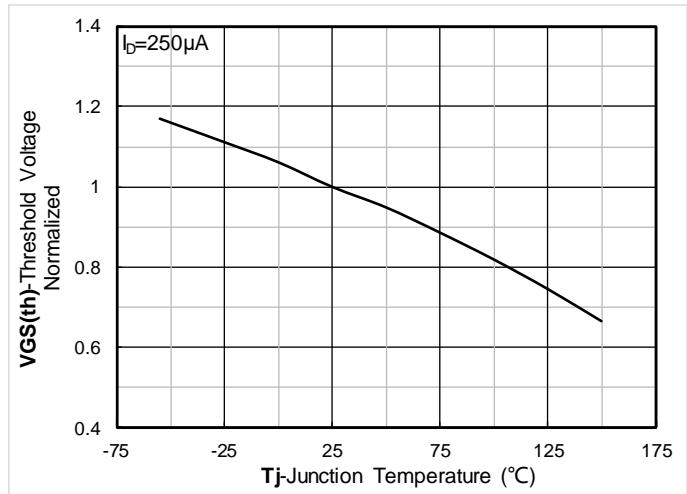


Figure 10. Normalized Threshold voltage

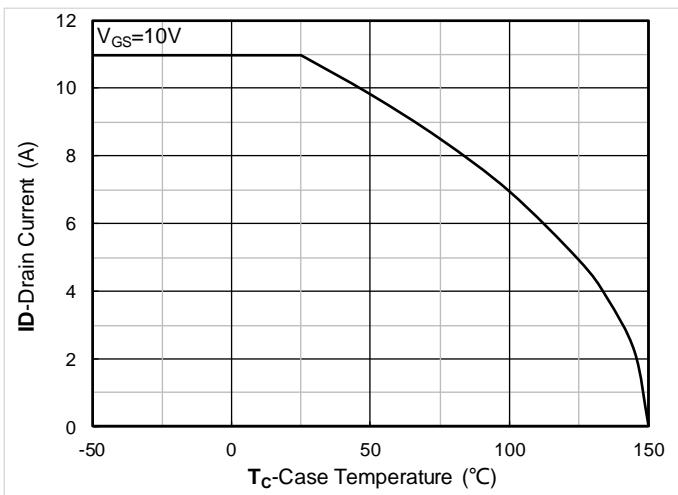


Figure 11. Current dissipation

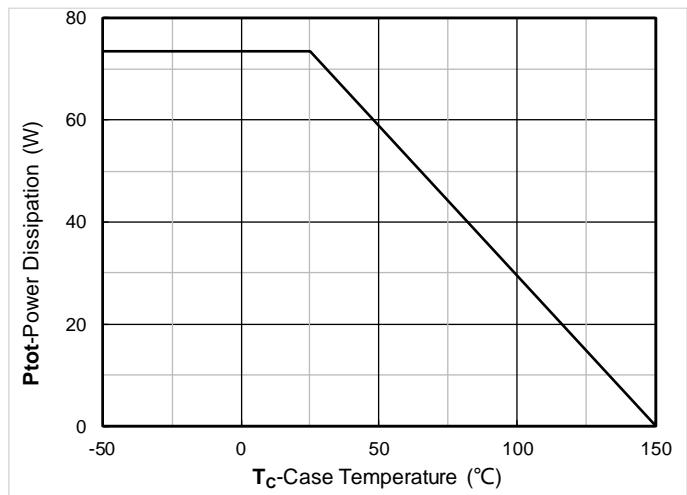


Figure 12. Power dissipation

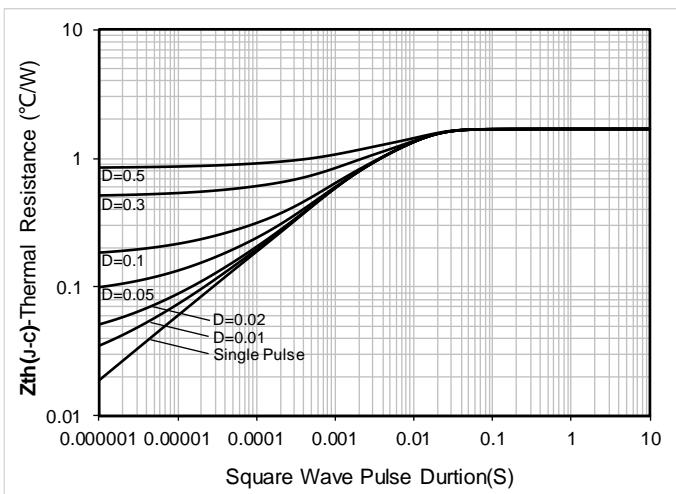


Figure 13. Maximum Transient Thermal Impedance

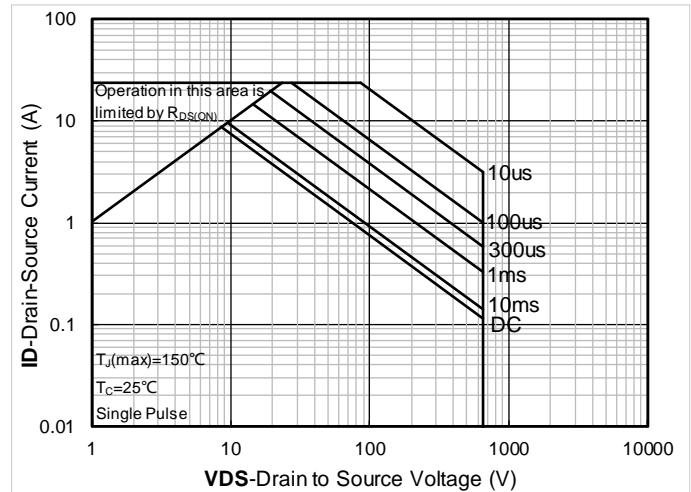


Figure 14. Safe Operation Area

## ■ Test Circuits & Waveforms

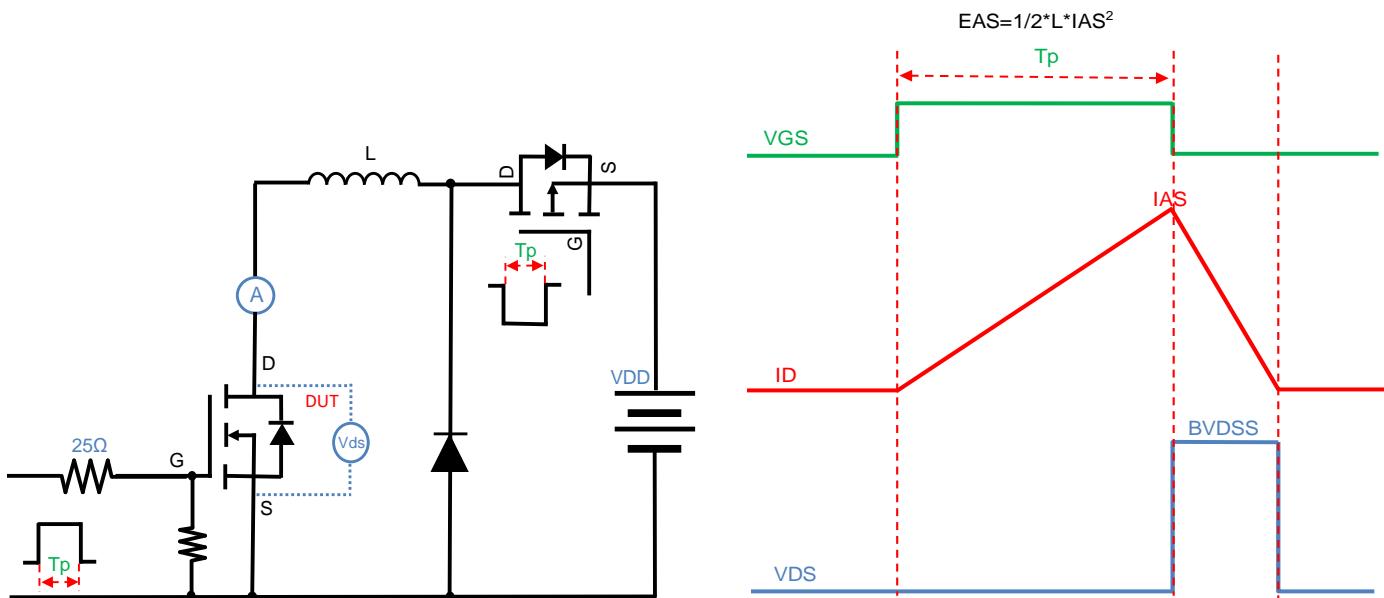


Figure A. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

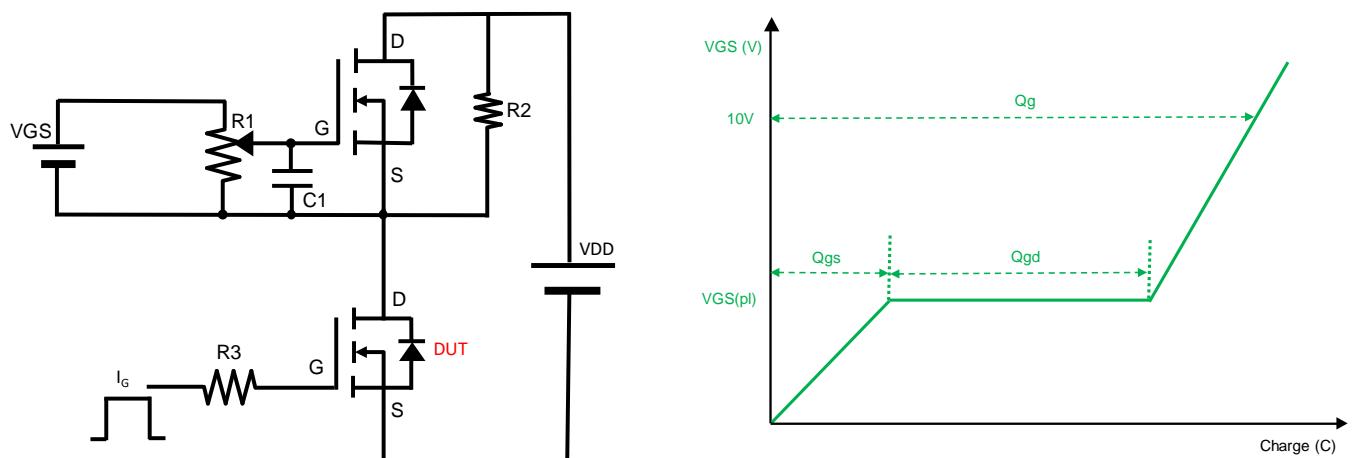


Figure B. Gate Charge Test Circuit & Waveform

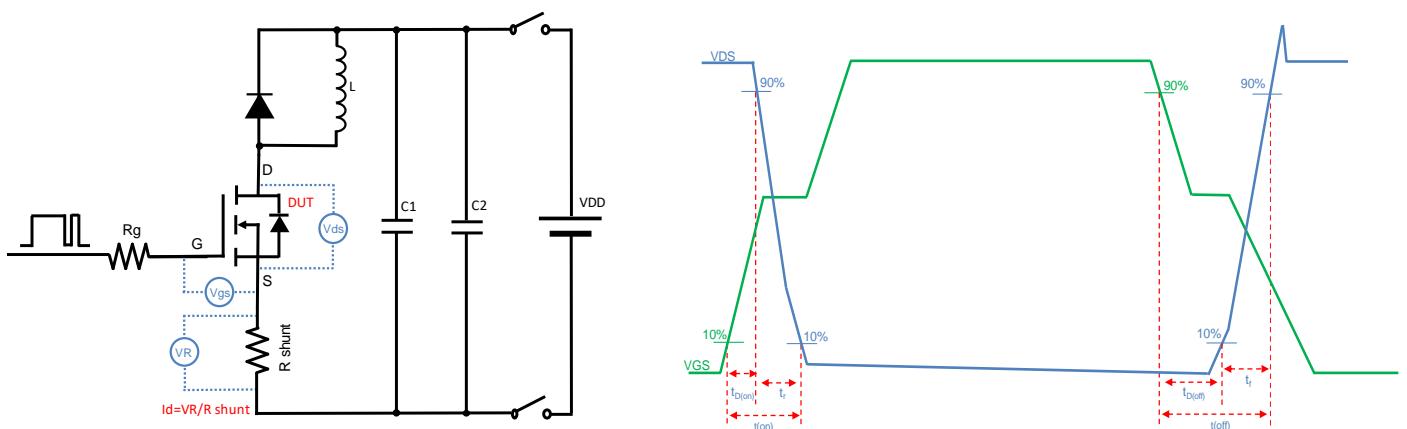


Figure C. Resistive Switching Test Circuit & Waveform

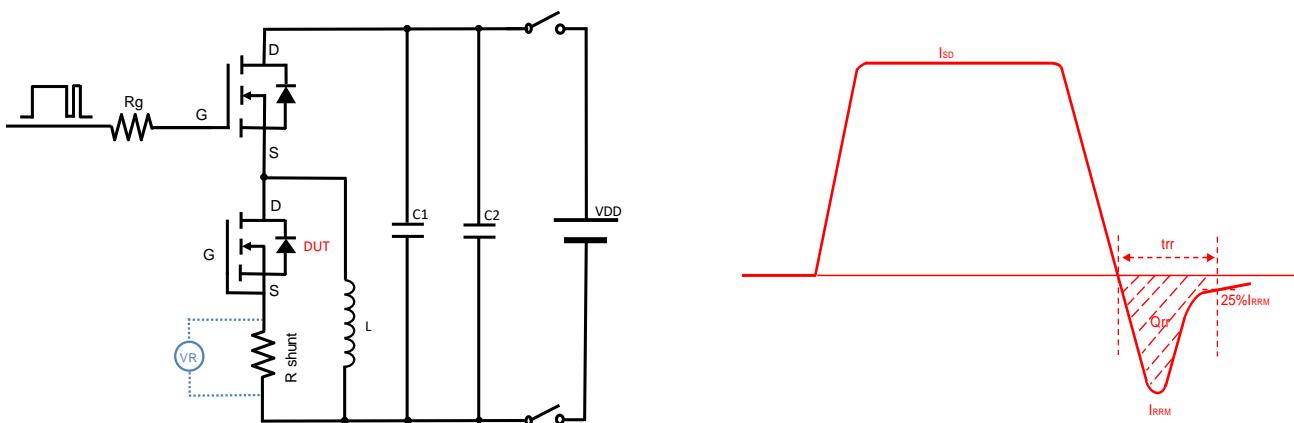
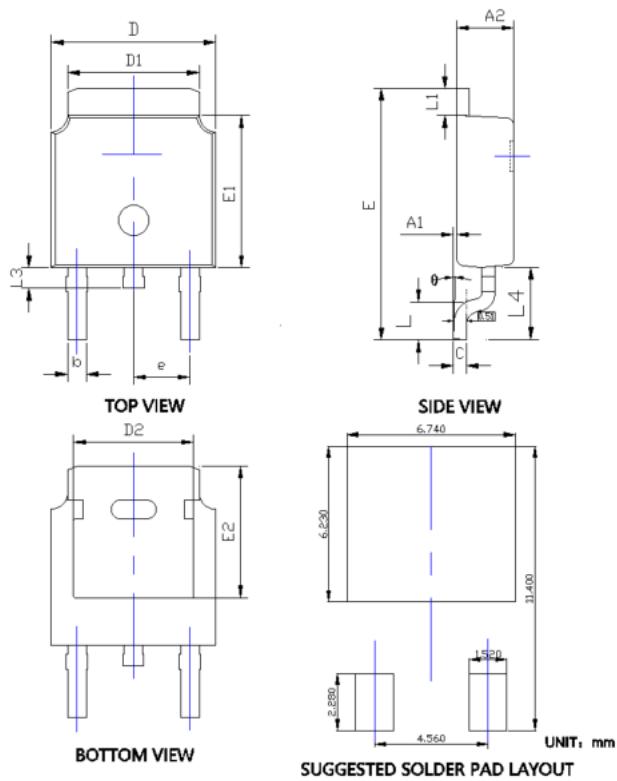


Figure D. Diode Recovery Test Circuit & Waveform

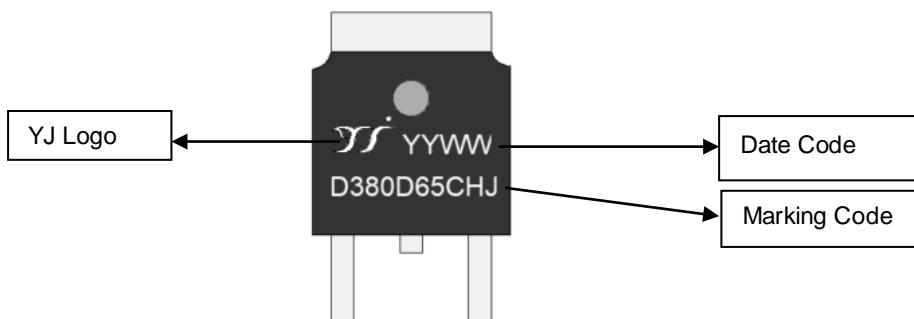


## ■ TO-252-C Package information



SYMBOL	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A1	0.000	0.008	0.000	0.200
A2	0.086	0.094	2.180	2.400
b	0.026	0.035	0.660	0.890
c	0.018	0.024	0.460	0.610
D	0.250	0.265	6.350	6.730
D1	0.195	0.215	4.950	5.460
D2	0.170	-	4.320	-
E	0.370	0.410	9.400	10.410
E1	0.235	0.245	5.970	6.220
E2	0.203	-	5.150	-
e	0.090	REF	2.286	REF
L	0.049	0.070	1.250	1.780
L1	0.035	0.050	0.890	1.270
L3	0.024	0.039	0.600	1.000
L4	0.102	0.126	2.600	3.200
theta	0°	10°	0°	10°

NOTE:  
1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.  
2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.  
3.THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.

**■ Marking Information****Note:**

1. All marking is at middle of the product body
2. All marking is in laser printing
3. D380D65CHJ is marking code, YYWW is date code, "YY" is year, "WW" is week
4. Body color: Black



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